SLLS095D - SEPTEMBER 1973 - REVISED OCTOBER 1998

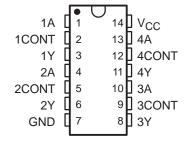
- Input Resistance . . . 3 k $\Omega$  to 7 k $\Omega$
- Input Signal Range . . . ±30 V
- Operate From Single 5-V Supply
- Built-In Input Hysteresis (Double Thresholds)
- Response Control that Provides: Input Threshold Shifting Input Noise Filtering
- Meet or Exceed the Requirements of TIA/EIA-232-F and ITU Recommendation V.28
- Fully Interchangeable With Motorola™ MC1489 and MC1489A

#### description

These devices are monolithic low-power Schottky quadruple line receivers designed to satisfy the requirements of the standard interface between data-terminal equipment and data-communication equipment as defined by TIA/EIA-232-F. A separate response-control (CONT) terminal is provided for each receiver. A resistor or a resistor and bias-voltage source can be connected between this terminal and ground to shift the input threshold levels. An external capacitor can be connected between this terminal and ground to provide input noise filtering.

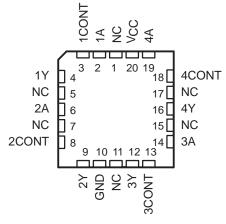
The SN55189 and SN55189A are characterized for operation over the full military temperature range of -55°C to 125°C. The MC1489, MC1489A, SN75189, and SN75189A are characterized for operation from 0°C to 70°C.

SN55189, SN55189A . . . J OR W PACKAGE MC1489, MC1489A, SN75189, SN75189A D, N, OR NS<sup>†</sup> PACKAGE (TOP VIEW)



† The NS package is only available left-end taped and reeled. For SN75189, order SN75189NSR.

## SN55189, SN55189A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

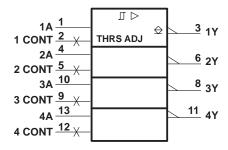


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Motorola is a trademark of Motorola, Incorporated.

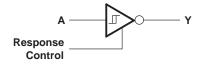


#### logic symbol†

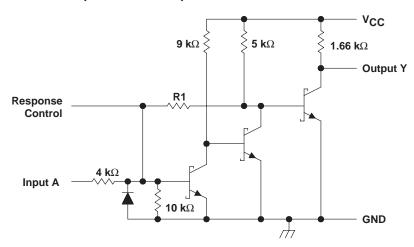


<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, NS, and W packages.

### logic diagram (positive logic)



#### schematic (each receiver)



	MC1489 SN55189 SN75189	MC1489A SN55189A SN75189A
R1	8.4 kΩ	1.84 kΩ

Resistor values shown are nominal.

#### MC1489, MC1489A, SN55189, SN55189A, SN75189, SN75189A QUADRUPLE LINE RECEIVERS

SLLS095D - SEPTEMBER 1973 - REVISED OCTOBER 1998

### 

NOTES: 1. All voltage values are with respect to the network ground terminal.

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{\scriptsize A}} \le 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	N/A
FK	1375 mW	11.0 mW/°C	880 mW	275 mW
J‡	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	N/A
NS	625 mW	4.0 mW/°C	445 mW	N/A
W	1000 mW	8.0 mW/°C	640 mW	200 mW

<sup>‡</sup> In the J package, SN55189 and SN55189A chips are either silver glass or alloy mounted.

#### recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	V
Input voltage, V <sub>I</sub>	-25		25	V
High-level output current, IOH			-0.5	mA
Low-level output current, IOL			10	mA
Operating free-air temperature, T <sub>A</sub>	0		70	°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## MC1489, MC1489A, SN55189, SN55189A, SN75189, SN75189A QUADRUPLE LINE RECEIVERS

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# electrical characteristics over operating free-air temperature range, $V_{\text{CC}}$ = 5 V $\pm$ 1% (unless otherwise noted)

I DADAMETED I		TEST FIGURE	TEST	TEST CONDITIONS†			\		89, MC14 SN75189 N75189 <i>A</i>		UNIT	
					MIN	TYP‡	MAX	MIN	TYP‡	MAX		
				T <sub>A</sub> = 25°C	1	1.3	1.5	1	1.3	1.5		
			'89	$T_A = 0$ °C to $70$ °C				0.9		1.6		
V <sub>IT+</sub>	Positive-going input	1		$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$	0.6		1.9				V	
*11+	threshold voltage	'		T <sub>A</sub> = 25°C	1.75	1.9	2.25	1.75	1.9	2.25	•	
			'89A	$T_A = 0$ °C to $70$ °C				1.55		2.25		
				$T_A = -55^{\circ}C$ to $125^{\circ}C$	1.30		2.65					
	Managhar astrontonal			T <sub>A</sub> = 25°C	0.75	1.0	1.25	0.75	1.0	1.25		
V <sub>IT</sub> — Negative-going input threshold voltage	1	'89, '89A	$T_A = 0$ °C to $70$ °C				0.65		1.25	V		
	tilleshold voltage			$T_A = -55^{\circ}C$ to $125^{\circ}C$	0.35		1.6					
Vон	High-level	1	$V_I = 0.75 V$ ,	$I_{OH} = -0.5 \text{ mA}$	2.6	4	5	2.6	4	5	V	
VOH	output voltage	'	Input open,	$I_{OH} = -0.5 \text{ mA}$	2.6	4	5	2.6	4	5	V	
VOL	Low-level output voltage	1	V <sub>I</sub> = 3 V,	I <sub>OL</sub> = 10 mA		0.2	0.45		0.2	0.45	<b>V</b>	
	High-level	2	V <sub>I</sub> = 25 V		3.6		8.3	3.6		8.3	mA	
ΊΗ	input current	2	V <sub>I</sub> = 3 V		0.43			0.43			IIIA	
i	Low-level	2	$V_{I} = -25 \text{ V}$		-3.6		-8.3	-3.6		-8.3	mA	
۱۱۲	input current		V <sub>I</sub> = −3 V		-0.43			-0.43			IIIA	
los	Short-circuit output current	3				-3			-3		mA	
ICC	Supply current	2	V <sub>I</sub> = 5 V,	Outputs open		20	26		20	26	mA	

<sup>†</sup> All characteristics are measured with the response-control terminal open.

## switching characteristics, $V_{CC}$ = 5 V, $C_L$ = 15 pF, $T_A$ = 25°C

	PARAMETER	TEST FIGURE	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low- to high-level output		$R_L = 3.9 \text{ k}\Omega$		25	85	no
tPHL	Propagation delay time, high- to low-level output	4	$R_L = 390 \Omega$		25	50	ns
tTLH	TLH Transition time, low- to high-level output		$R_L = 3.9 \text{ k}\Omega$		120	175	
tTHL	Transition time, high- to low-level output		$R_L = 390 \Omega$		10	20	ns

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### PARAMETER MEASUREMENT INFORMATION<sup>†</sup>

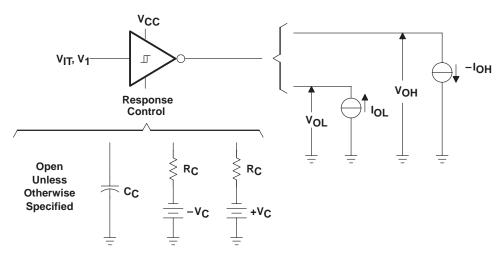
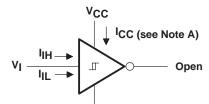


Figure 1.  $V_{IT+}$ ,  $V_{IT-}$ ,  $V_{OH}$ ,  $V_{OL}$ 



**Response Control Open** 

NOTE A:  $I_{CC}$  is tested for all four receivers simultaneously.

Figure 2.  $I_{IH}$  ,  $I_{IL}$  ,  $I_{CC}$ 

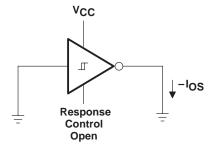
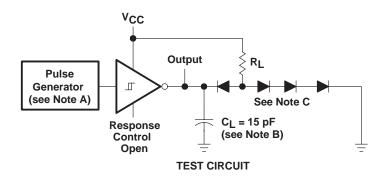
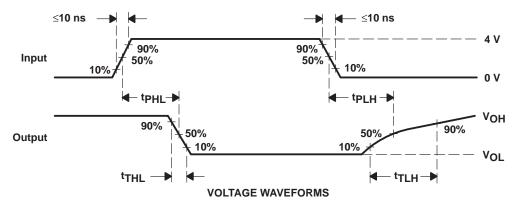


Figure 3. Ios

<sup>&</sup>lt;sup>†</sup> Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

#### PARAMETER MEASUREMENT INFORMATION





NOTES: A. The pulse generator has the following characteristics:  $Z_0 = 50 \Omega$ ,  $t_W = 500 \text{ ns}$ .

- B. C<sub>L</sub> includes probe and jig capacitances.
- C. All diodes are 1N3064 or equivalent.

Figure 4. Test Circuit and Voltage Waveforms

#### TYPICAL CHARACTERISTICS

SN65189, SN75189 OUTPUT VOLTAGE vs

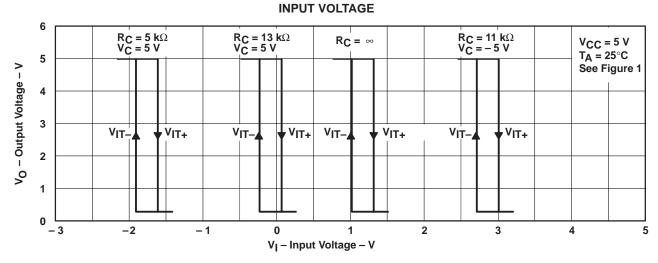


Figure 5

SN65189A, SN75189A OUTPUT VOLTAGE

INPUT VOLTAGE

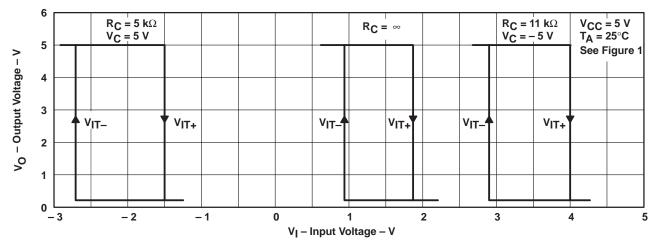


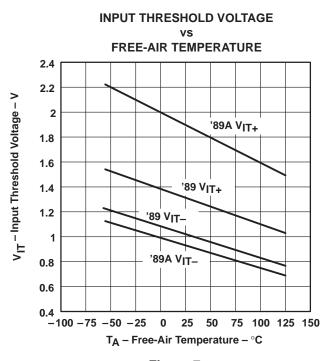
Figure 6

#### TYPICAL CHARACTERISTICS<sup>†</sup>

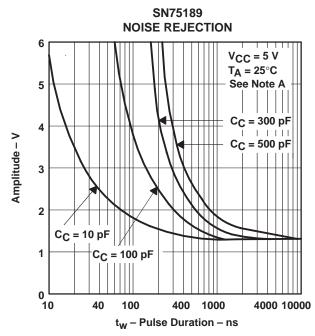
0.2

2

3







NOTE A: Maximum amplitude of a positive-going pulse that, starting from 0 V, will not cause a change in the output level.

SUPPLY VOLTAGE

2
1.8
789A VIT+
789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT-

INPUT THRESHOLD VOLTAGE

Figure 8

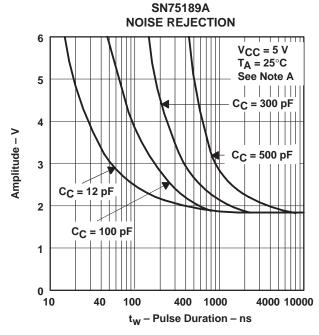
6

V<sub>CC</sub> - Supply Voltage - V

8

9

10



NOTE A: Maximum amplitude of a positive-going pulse that, starting from 0 V, will not cause a change in the output level.

Figure 9 Figure 10

<sup>†</sup> Data for free-air temperatures below 0°C and above 70°C are applicable to SN55189 and SN55189A circuits only.



#### **TYPICAL CHARACTERISTICS**

#### **INPUT CURRENT** vs **INPUT VOLTAGE** 10 $V_{CC} = 5 V$ 8 **Control Open** $T_A = 25^{\circ}C$ 6 I<sub>I</sub> - Input Current - mA 2 0 -2 -4 -6 -8 -10 5 10 -25 -20 -15 -10 -5 0 15 20

Figure 11

V<sub>I</sub> - Input Voltage - V

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#### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-86888022A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 86888022A SNJ55 189AFK	Samples
5962-8688802CA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8688802CA SNJ55189AJ	Samples
5962-8688802DA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type -55 to 125		5962-8688802DA SNJ55189AW	Samples
MC1489AN	LIFEBUY	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	MC1489AN	
MC1489N	LIFEBUY	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	MC1489N	
MC1489NE4	LIFEBUY	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	MC1489N	
SN55189AJ	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN55189AJ	Samples
SN75189AD	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189A	Samples
SN75189ADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189A	Samples
SN75189ADRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189A	Samples
SN75189AN	LIFEBUY	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN75189AN	
SN75189ANSR	LIFEBUY	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189A	
SN75189ANSRG4	LIFEBUY	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189A	
SN75189APWR	LIFEBUY	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		A189A	
SN75189D	LIFEBUY	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189	
SN75189DR	LIFEBUY	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189	
SN75189N	LIFEBUY	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN75189N	
SN75189NSR	LIFEBUY	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75189	
SNJ55189AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 86888022A SNJ55 189AFK	Samples
SNJ55189AJ	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8688802CA SNJ55189AJ	Samples

### PACKAGE OPTION ADDENDUM

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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SNJ55189AW	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8688802DA SNJ55189AW	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL. Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN55189A, SN75189A:

## **PACKAGE OPTION ADDENDUM**

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• Military : SN55189A

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75189ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN75189ANSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN75189APWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN75189DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN75189NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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#### \*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75189ADR	SOIC	D	14	2500	340.5	336.1	32.0
SN75189ANSR	so	NS	14	2000	356.0	356.0	35.0
SN75189APWR	TSSOP	PW	14	2000	356.0	356.0	35.0
SN75189DR	SOIC	D	14	2500	356.0	356.0	35.0
SN75189NSR	SO	NS	14	2000	356.0	356.0	35.0

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#### **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-86888022A	FK	LCCC	20	1	506.98	12.06	2030	NA
5962-8688802DA	W	CFP	14	1	506.98	26.16	6220	NA
MC1489AN	N	PDIP	14	25	506	13.97	11230	4.32
MC1489N	N	PDIP	14	25	506	13.97	11230	4.32
MC1489NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN75189AD	D	SOIC	14	50	507	8	3940	4.32
SN75189AD	D	SOIC	14	50	506.6	8	3940	4.32
SN75189AN	N	PDIP	14	25	506	13.97	11230	4.32
SN75189AN	N	PDIP	14	25	506	13.97	11230	4.32
SN75189D	D	SOIC	14	50	506.6	8	3940	4.32
SN75189N	N	PDIP	14	25	506	13.97	11230	4.32
SNJ55189AFK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ55189AW	W	CFP	14	1	506.98	26.16	6220	NA

#### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## W (R-GDFP-F14)

### CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



## D (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



## D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
  - Sody length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



## PW (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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